

# N-Channel 100 V (D-S) 175 °C MOSFET

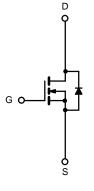
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	V <sub>DS</sub> (V) R <sub>DS(on)</sub> (Ω)			
100	0.006 at V <sub>GS</sub> = 10 V	150		

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- New Package with Low Thermal Resistance
- 100 % R<sub>g</sub> Tested







N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25 \text{ °C}$ , unless otherwise noted							
Parameter	Symbol	Limit	Unit				
Drain-Source Voltage	V <sub>DS</sub>	100	V				
Gate-Source Voltage	V <sub>GS</sub>	/ <sub>GS</sub> ± 20					
Continuous Drain Current (T $= 175$ °C)	T <sub>C</sub> = 25 °C		150	^			
Continuous Drain Current ( $T_J = 175 \text{ °C}$ )	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	100 <sup>a</sup>				
Pulsed Drain Current	I <sub>DM</sub>	600	A				
Avalanche Current	I <sub>AR</sub>	75					
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	280	mJ			
Maximum Dirationticab	T <sub>C</sub> = 25 °C	D	375 <sup>c</sup>	W			
Maximum Power Dissipation <sup>b</sup>	T <sub>A</sub> = 25 °C	– P <sub>D</sub> –	3.75	vv V			
Operating Junction and Storage Temperatu	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C				

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	TO-247	R <sub>thJA</sub>	40	°C/W		
Junction-to-Case (Drain)	R <sub>thJC</sub>	0.5	C/VV			

Notes:

a. Package limited.

b. Duty cycle  $\leq$  1 %. c. See SOA curve for voltage derating.

$\begin{tabular}{ c c c c c c } \hline Parameter & Symbol & Test Conditions \\ \hline \hline Static & & & & & & & & & \\ \hline Static & & & & & & & & & \\ \hline Drain-Source Breakdown Voltage & V_{DS} & V_{DS} = 0 V, I_D = 250 \ \mu A \\ \hline Gate-Threshold Voltage & V_{GS(th)} & V_{DS} = V_{GS}, I_D = 250 \ \mu A \\ \hline Gate-Body Leakage & I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline Zero \ Gate \ Voltage \ Drain \ Current & I_{DSS} & V_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_J = 125 \ ^C \\ \hline V_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_J = 175 \ ^C \\ \hline On-State \ Drain \ Current^a & I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline \end{tabular}$	Min. 100 2	Typ.	Max. 4 ± 100 1 50	Vnit V nA	
$\begin{tabular}{ c c c c c } \hline Drain-Source Breakdown Voltage & V_{DS} & V_{DS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline Gate-Threshold Voltage & V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline Gate-Body \ Leakage & I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline Zero \ Gate \ Voltage \ Drain \ Current & I_{DSS} & V_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_J = 125 \ ^{\circ}C \\ \hline V_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_J = 175 \ ^{\circ}C \\ \hline \end{array}$	2		± 100	nA	
$ \begin{array}{c c} \mbox{Gate-Threshold Voltage} & V_{GS(th)} & V_{DS} = V_{GS}, \mbox{I}_D = 250 \ \mu \mbox{A} \\ \mbox{Gate-Body Leakage} & I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \mbox{Zero Gate Voltage Drain Current} & I_{DSS} & \frac{V_{DS} = 100 \ V, \ V_{GS} = 0 \ V}{V_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_J = 125 \ ^{\circ}\ C} \\ \mbox{V}_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_J = 175 \ ^{\circ}\ C} \end{array} $	2		± 100	nA	
Gate-Body LeakageI GSS $V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$ Zero Gate Voltage Drain CurrentI DSS $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$			± 100	nA	
$ \begin{array}{c c} \mbox{Gate-Body Leakage} & I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \mbox{Zero Gate Voltage Drain Current} & I_{DSS} & \frac{V_{DS} = 100 \ V, \ V_{GS} = 0 \ V}{V_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_J = 125 \ ^{\circ}C} \\ \ \hline V_{DS} = 100 \ V, \ V_{GS} = 0 \ V, \ T_J = 175 \ ^{\circ}C \end{array} $	120		1		
Zero Gate Voltage Drain Current $I_{DSS}$ $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ $V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$	120				
V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C	120		50		
	120			μA	
On-State Drain Current <sup>a</sup> $I_{D(on)}$ $V_{DS} \ge 5 V, V_{CS} = 10 V$	120		250		
D(01) D5 7 05				A	
V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.006			
Drain-Source On-State Resistance <sup>a</sup> $R_{DS(on)}$ $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 \text{ °C}$		0.017		Ω	
V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C		0.025		1	
Forward Transconductance <sup>a</sup> $g_{fs}$ $V_{DS} = 15 \text{ V}, I_D = 30 \text{ A}$	25			S	
Dynamic <sup>b</sup>					
Input Capacitance C <sub>iss</sub>		6700		pF	
Output Capacitance $C_{oss}$ $V_{GS}$ = 0 V, $V_{DS}$ = 25 V, f = 1 MHz		750			
Reverse Transfer Capacitance C <sub>rss</sub>		280			
Total Gate Charge <sup>c</sup> Q <sub>g</sub>		110	160		
Gate-Source Charge <sup>c</sup> $Q_{gs}$ $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 85 \text{ A}$		24		nC	
Gate-Drain Charge <sup>c</sup> Q <sub>gd</sub>		24			
Gate Resistance R <sub>g</sub>	1.0		6.2	Ω	
Turn-On Delay Time <sup>c</sup> t <sub>d(on)</sub>		20	30		
Rise Time <sup>c</sup> $t_r$ $V_{DD} = 50 \text{ V}, \text{ R}_L = 0.6 \Omega$		125	200	20	
Turn-Off Delay Time <sup>c</sup> $t_{d(off)}$ $I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		55	85	ns	
Fall Time <sup>c</sup> t <sub>f</sub>		130	195		
Source-Drain Diode Ratings and Characteristics T <sub>C</sub> = 25 °C <sup>b</sup>	•				
Continuous Current I <sub>S</sub>			110	А	
Pulsed Current I <sub>SM</sub>			240	A	
Forward Voltage <sup>a</sup> $V_{SD}$ $I_F = 85 \text{ A}, V_{GS} = 0 \text{ V}$		1.0	1.5	V	
Reverse Recovery Time t <sub>rr</sub>		70	140	ns	
Peak Reverse Recovery Charge $I_{RM(REC)}$ $I_F = 50 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		5.5	10	А	
Reverse Recovery Charge Q <sub>rr</sub>		0.19	0.35	μC	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

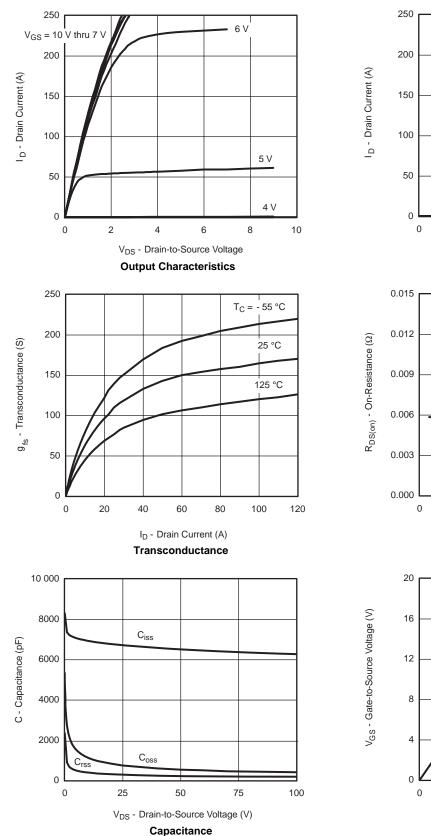
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

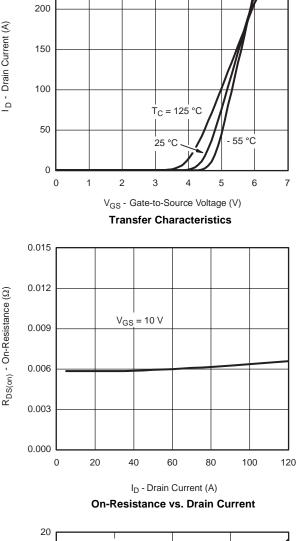
emi

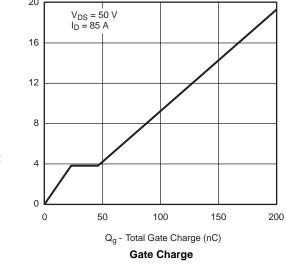
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

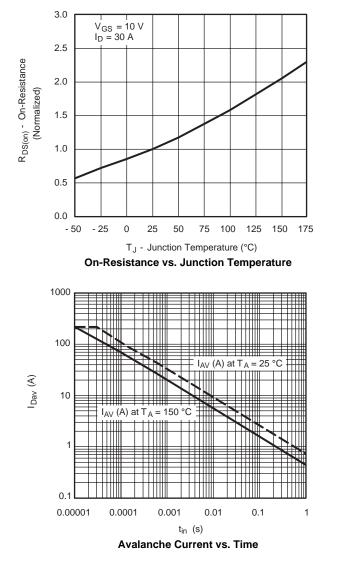


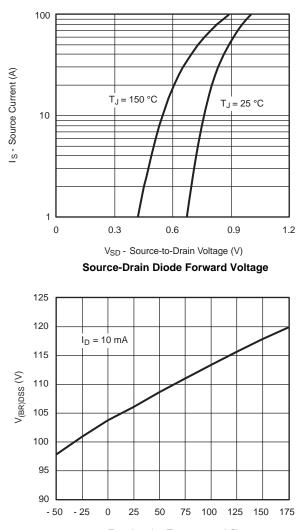


服务热线:400-655-8788



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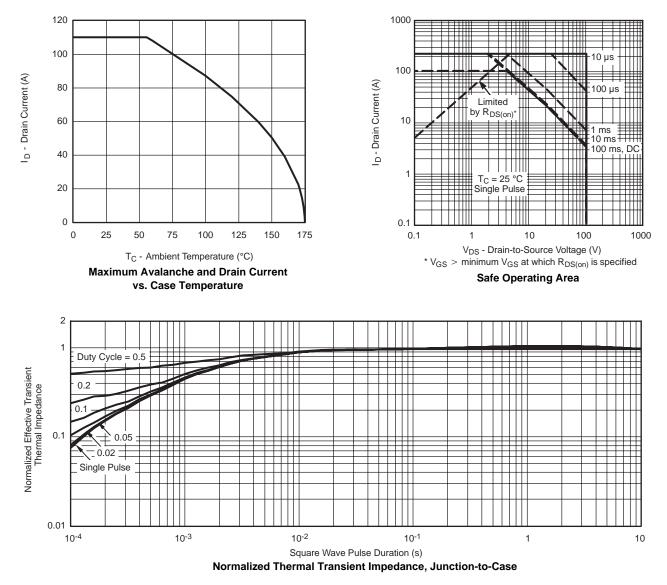


T<sub>J</sub> - Junction Temperature (°C) Drain Source Breakdown vs. Junction Temperature

### IRFP4410ZPBF



### **THERMAL RATINGS**



b4

b5

С

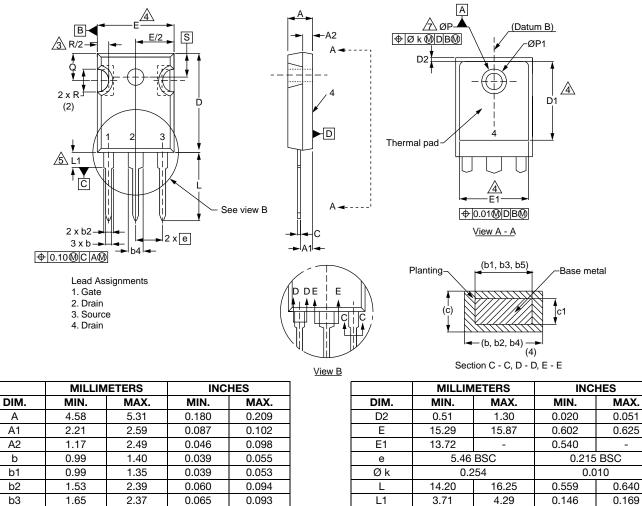
c1

D

D1



**TO-247AC** 



4.58	5.31	0.180	0.209	D2	0.51	1.30	0.020	0.0
2.21	2.59	0.087	0.102	E	15.29	15.87	0.602	0.6
1.17	2.49	0.046	0.098	E1	13.72	-	0.540	-
0.99	1.40	0.039	0.055	е	5.46 BSC		0.215 BSC	
0.99	1.35	0.039	0.053	Øk	0.254		0.010	
1.53	2.39	0.060	0.094	L	14.20	16.25	0.559	0.6
1.65	2.37	0.065	0.093	L1	3.71	4.29	0.146	0.1
2.42	3.43	0.095	0.135	N	7.62 BSC		0.300 BSC	
2.59	3.38	0.102	0.133	ØΡ	3.51	3.66	0.138	0.1
0.38	0.86	0.015	0.034	Ø P1	-	7.39	-	0.2
0.38	0.76	0.015	0.030	Q	5.31	5.69	0.209	0.2
19.71	20.82	0.776	0.820	R	4.52	5.49	0.178	0.2
13.08	-	0.515	-	S	5.51 BSC		0.217 BSC	

0.144

0.291

0.224

0.216



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